

#### Data Sheet

#### March 4, 2010

# Dual, Low Power CMOS Operational Amplifiers

intercil

The ICL761X/762X series is a family of monolithic CMOS operational amplifiers. These devices provide the designer with high performance operation at low supply voltages and selectable quiescent currents. They are an ideal design tool when ultra low input current and low power dissipation are desired.

The basic amplifier will operate at supply voltages ranging from  $\pm 1V$  to  $\pm 8V$ , and may be operated from a single Lithium cell. The output swing ranges to within a few millivolts of the supply voltages.

The quiescent supply current of these amplifiers is set to  $100\mu A$  at the factory. This results in power consumption as low as  $200\mu W$  per amplifier.

Of particular significance is the extremely low (1pA) input current, input noise current of  $0.01 \text{pA}/\sqrt{\text{Hz}}$ , and  $10^{12}\Omega$  input impedance. These features optimize performance in very high source impedance applications.

The inputs are internally protected. Outputs are fully protected against short circuits to ground or to either supply.

Because of the low power dissipation, junction temperature rise and drift are quite low. Applications utilizing these features may include stable instruments, extended life designs, or high density packages.

#### Ordering Information

PART NUMBER	PART MARKING	TEMP. RANGE (°C)	PACKAGE	PKG. DWG. #
ICL7621DCPA	7621 DCPA	0 to +70	8 Ld PDIP - D Grade - I <sub>Q</sub> = 100µA	E8.3
ICL7621DCPAZ* (Note 2)	7621 DCPAZ	0 to +70	8 Ld PDIP - D Grade - I <sub>Q</sub> = 100µA	E8.3
ICL7621DCBA (Note 1)	7621 DCBA	0 to +70	8 Ld SOIC - D Grade - I <sub>Q</sub> = 100µA	M8.15
ICL7621DCBAZ (Notes 1, 2)	7621 DCBAZ	0 to +70	8 Ld SOIC - D Grade - I <sub>Q</sub> = 100μA	M8.15

\*Pb-free PDIPs can be used for through hole wave solder processing only. They are not intended for use in Reflow solder processing applications. NOTES:

- 1. Add "-T" suffix for tape and reel. Please refer to TB347 for details on reel specifications.
- 2. These Intersil Pb-free plastic packaged products employ special Pb-free material sets, molding compounds/die attach materials, and 100% matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations). Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.

#### Features

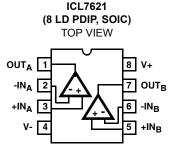
• V	Vide Operating	Voltage Range	$\pm 1V$ to $\pm 8V$
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- Input Current Lower Than BIFETs ..... 1pA (Typ)
- Output Voltage Swing ......V+ and V-
- · Available as Duals (Refer to ICL7611 for Singles)
- Low Power Replacement for Many Standard Op Amps

#### Applications

- Portable Instruments
- Telephone Headsets
- Hearing Aid/Microphone Amplifiers
- Meter Amplifiers
- Medical Instruments
- High Impedance Buffers

### Pinouts



#### **Absolute Maximum Ratings**

Supply Voltage V+ to V18V
Input Voltage V0.3 to V+ +0.3V
Differential Input Voltage (Note 3) [(V+ +0.3) - (V0.3)]V
Duration of Output Short Circuit (Note 4) Unlimited

#### **Operating Conditions**

Temperature Range ...... 0°C to +70°C

#### **Thermal Information**

Thermal Resistance (Typical, Note 5)	θ <sub>JA</sub> (°C/W)	θ <sub>JC</sub> (°C/W)
PDIP Package	120	N/A
SOIC Package	160	N/A
Maximum Junction Temperature (Plastic F	Package)	+150°C
Maximum Storage Temperature Range	65	°C to +150°C
Pb-Free Reflow Profile	s	ee link below
http://www.intersil.com/pbfree/Pb-FreeF	Reflow.asp	
*Pb-free PDIPs can be used for thr	ough hole	wave solder
processing only. They are not intended	for use in R	leflow solder
processing applications.		

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

NOTES:

- 3. Long term offset voltage stability will be degraded if large input differential voltages are applied for long periods of time.
- The outputs may be shorted to ground or to either supply, for V<sub>SUPPLY</sub> ≤10V. Care must be taken to insure that the dissipation rating is not exceeded.
- 5.  $\theta_{JA}$  is measured with the component mounted on an evaluation PC board in free air.

#### TEMP. MAX MIN PARAMETER SYMBOL **TEST CONDITIONS** TYP (Note 6) UNITS (Note 6) (°C) $R_S \le 100 k\Omega$ Input Offset Voltage +25 15 m\/ Vos \_ Full 20 mV \_ µV/<sup>0</sup>C Temperature Coefficient of VOS $\Delta V_{OS} / \Delta T$ $R_S \leq 100 k\Omega$ \_ \_ 25 -+25 Input Offset Current 0.5 los -30 pА 0 to +70 -300 pA \_ -55 to +125 800 pА -Input Bias Current +25 1.0 50 pА IBIAS \_ 0 to +70 -400 pА --55 to +125 4000 pА Common Mode Voltage Range $I_{Q} = 100 \mu A$ +25 V VCMR +4.2\_ -**Output Voltage Swing** $I_{\Omega} = 100 \mu A, R_{I} = 100 k \Omega$ +25 ±4.9 V VOUT -\_ 0 to +70 ±4.8 V -\_ -55 to +125 ±4.5 \_ \_ V 80 Large Signal Voltage Gain $V_{O} = \pm 4.0V, R_{L} = 100k\Omega, I_{Q} = 100\mu A$ +25 102 dB AVOL \_ 0 to +70 75 \_ dB \_ -55 to +125 68 dB \_ \_ Unity Gain Bandwidth GBW $I_Q = 100 \mu A$ +25 0.48 MHz \_ \_ 10<sup>12</sup> Input Resistance +25 Ω RIN \_ \_ Common Mode Rejection Ratio CMRR +25 70 91 $R_S \leq 100 k\Omega$ , $I_Q = 100 \mu A$ dB \_ PSRR $R_S \le 100 k\Omega$ , $I_Q$ = 100 $\mu$ A +25 80 86 dB Power Supply Rejection Ratio \_ $(V_{SUPPLY} = \pm 8V \text{ to } \pm 2V)$ nV/√Hz Input Referred Noise Voltage $R_S = 100\Omega$ , f = 1kHz +25 100 e<sub>N</sub> \_ \_ pA/√Hz Input Referred Noise Current $R_{S} = 100\Omega, f = 1kHz$ +25 0.01 \_ İΝ \_ Supply Current (Per Amplifier) ISUPPLY No Signal, No Load, I<sub>Q</sub> = 100µA +25 \_ 0.1 0.25 mΑ **Channel Separation** +25 120 dB V<sub>01</sub>/V<sub>02</sub> $A_{V} = 100$ \_

### **Electrical Specifications** $V_{SUPPLY}$ = ±5V, Unless Otherwise Specified.

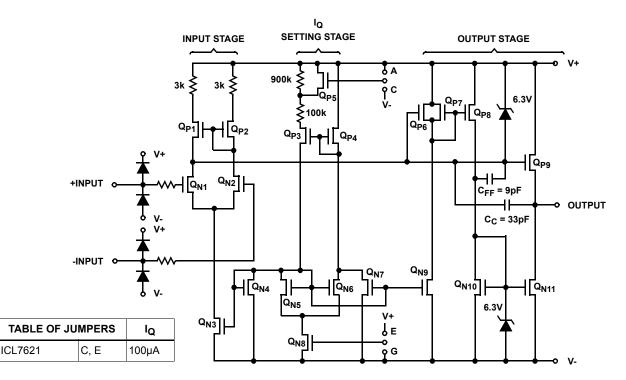
PARAMETER	SYMBOL	TEST CONDITIONS	TEMP. (°C)	MIN (Note 6)	ТҮР	MAX (Note 6)	UNITS
Slew Rate	SR	$A_V$ = 1, C <sub>L</sub> = 100pF, V <sub>IN</sub> = 8V <sub>P-P</sub> , I <sub>Q</sub> = 100μA, R <sub>L</sub> = 100kΩ	+25	-	0.16	-	V/µs
Rise Time	t <sub>R</sub>	V <sub>IN</sub> = 50mV, C <sub>L</sub> = 100pF, I <sub>Q</sub> = 100μA, R <sub>L</sub> = 100kΩ	+25	-	2	-	μs
Overshoot Factor	OS	$V_{IN}$ = 50mV, C <sub>L</sub> = 100pF, I <sub>Q</sub> = 100μA, R <sub>L</sub> = 100kΩ	+25	-	10	-	%

**Electrical Specifications**  $V_{SUPPLY}$  = ±5V, Unless Otherwise Specified. (Continued)

NOTE:

6. Parameters with MIN and/or MAX limits are 100% tested at +25°C, unless otherwise specified. Temperature limits established by characterization and are not production tested.

### Schematic Diagram



### Application Information

### Static Protection

All devices are static protected by the use of input diodes. However, strong static fields should be avoided, as it is possible for the strong fields to cause degraded diode junction characteristics, which may result in increased input leakage currents.

#### Latchup Avoidance

Junction-isolated CMOS circuits employ configurations which produce a parasitic 4-layer (PNPN) structure. The 4-layer structure has characteristics similar to an SCR, and under certain circumstances may be triggered into a low impedance state resulting in excessive supply current. To avoid this condition, no voltage greater than 0.3V beyond the supply rails may be applied to any pin. In general, the op amp supplies must be established simultaneously with, or before any input signals are applied. If this is not possible, the drive circuits must limit input current flow to 2mA to prevent latchup.

### Choosing the Proper IQ

Each device in the ICL76XX family has a similar I<sub>Q</sub> setup scheme, which allows the amplifier to be set to nominal quiescent currents of 10µA, 100µA or 1mA. These current settings change only very slightly over the entire supply voltage range. The ICL7611/12 have an external I<sub>Q</sub> control terminal, permitting user selection of each amplifiers' quiescent current. The ICL7621 has a fixed I<sub>Q</sub> setting of 100µA.

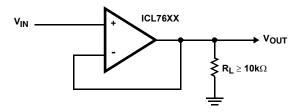
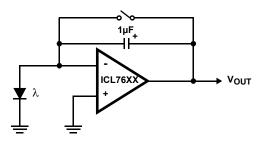


FIGURE 1. SIMPLE FOLLOWER



NOTE: Low leakage currents allow integration times up to several hours.

#### FIGURE 3. PHOTOCURRENT INTEGRATOR

#### **Output Stage and Load Driving Considerations**

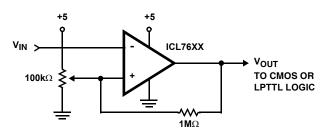
Each amplifiers' quiescent current flows primarily in the output stage. This is approximately 70% of the  $I_Q$  settings. This allows output swings to almost the supply rails for output loads of  $1M\Omega$ ,  $100k\Omega$ , and  $10k\Omega$ , using the output stage in a highly linear class A mode. In this mode, crossover distortion is avoided and the voltage gain is maximized. However, the output stage can also be operated in Class AB for higher output currents (see graphs in "Typical Performance Curves" beginning on page 6). During the transition from Class A to Class B operation, the output transfer characteristic is nonlinear and the voltage gain decreases.

#### Frequency Compensation

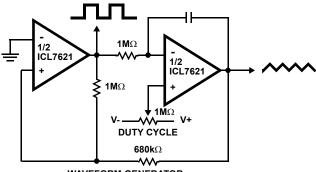
The ICL76XX are internally compensated, and are stable for closed loop gains as low as unity with capacitive loads up to 100pF.

## **Typical Applications**

The user is cautioned that, due to extremely high input impedances, care must be exercised in layout, construction, board cleanliness, and supply filtering to avoid hum and noise pickup.



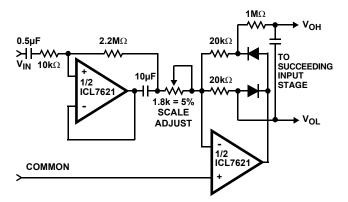


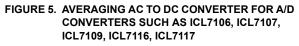


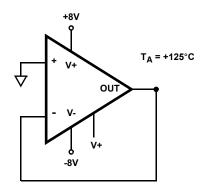
WAVEFORM GENERATOR

NOTE: Since the output range swings exactly from rail to rail, frequency and duty cycle are virtually independent of power supply variations.

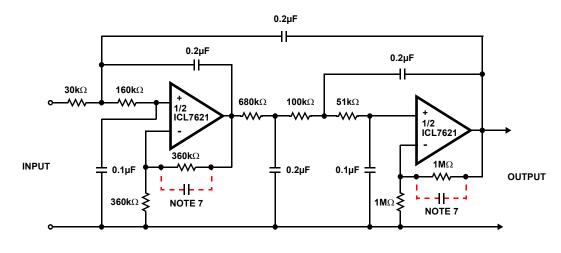
#### FIGURE 4. TRIANGLE/SQUARE WAVE GENERATOR







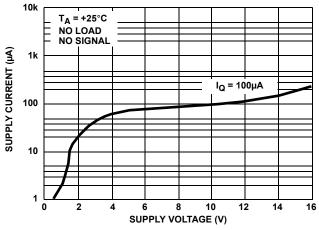




NOTES:

- 7. Small capacitors (25pF to 50pF) may be needed for stability in some cases.
- 8. The low bias currents permit high resistance and low capacitance values to be used to achieve low frequency cutoff.  $f_c = 10Hz$ ,  $AV_{CL} = 4$ , Passband ripple = 0.1dB.

#### FIGURE 7. FIFTH ORDER CHEBYCHEV MULTIPLE FEEDBACK LOW PASS FILTER



### **Typical Performance Curves**



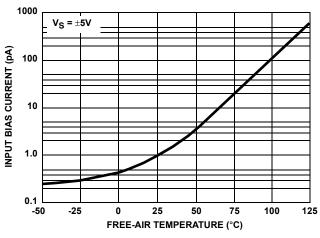


FIGURE 10. INPUT BIAS CURRENT vs TEMPERATURE

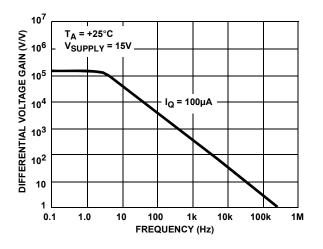


FIGURE 12. LARGE SIGNAL FREQUENCY RESPONSE

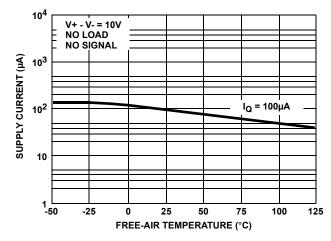


FIGURE 9. SUPPLY CURRENT PER AMPLIFIER vs FREE-AIR TEMPERATURE

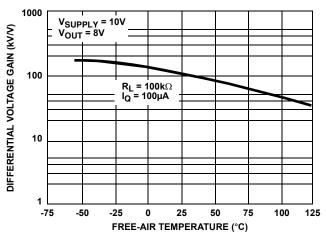
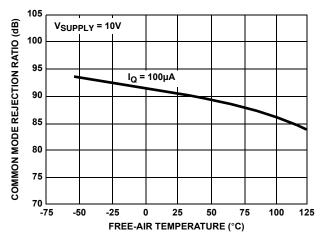
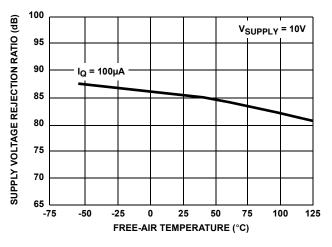


FIGURE 11. LARGE SIGNAL DIFFERENTIAL VOLTAGE GAIN vs FREE-AIR TEMPERATURE

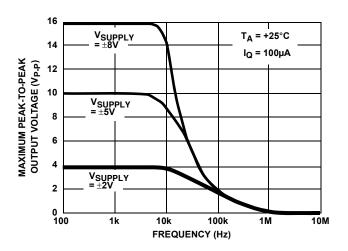




### Typical Performance Curves (Continued)









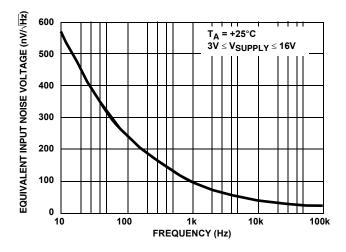


FIGURE 15. EQUIVALENT INPUT NOISE VOLTAGE vs FREQUENCY

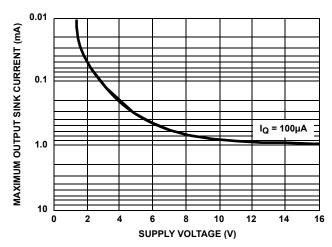


FIGURE 17. OUTPUT SINK CURRENT vs SUPPLY VOLTAGE

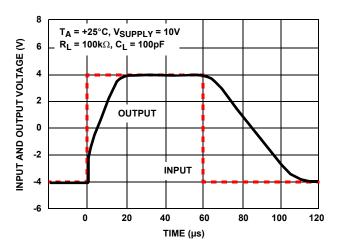
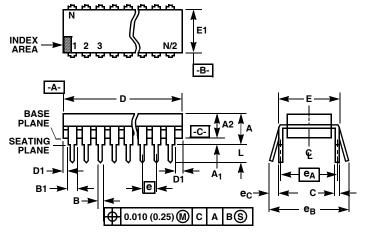


FIGURE 18. VOLTAGE FOLLOWER LARGE SIGNAL PULSE RESPONSE (I<sub>Q</sub> =  $100\mu$ A)

## Dual-In-Line Plastic Packages (PDIP)



#### NOTES:

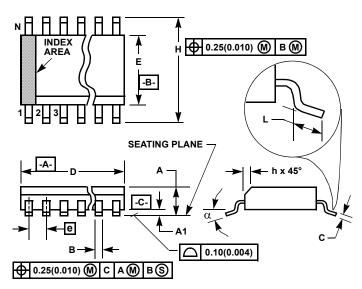
- 1. Controlling Dimensions: INCH. In case of conflict between English and Metric dimensions, the inch dimensions control.
- 2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
- 3. Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication No. 95.
- 4. Dimensions A, A1 and L are measured with the package seated in JEDEC seating plane gauge GS-3.
- D, D1, and E1 dimensions do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.010 inch (0.25mm).
- 6. E and eA are measured with the leads constrained to be perpendicular to datum -C-.
- 7.  $e_B$  and  $e_C$  are measured at the lead tips with the leads unconstrained.  $e_C$  must be zero or greater.
- 8. B1 maximum dimensions do not include dambar protrusions. Dambar protrusions shall not exceed 0.010 inch (0.25mm).
- 9. N is the maximum number of terminal positions.
- Corner leads (1, N, N/2 and N/2 + 1) for E8.3, E16.3, E18.3, E28.3, E42.6 will have a B1 dimension of 0.030 - 0.045 inch (0.76 - 1.14mm).

#### E8.3 (JEDEC MS-001-BA ISSUE D) 8 LEAD DUAL-IN-LINE PLASTIC PACKAGE

	INC	HES	MILLIMETERS		
SYMBOL	MIN	MAX	MIN	MAX	NOTES
А	-	0.210	-	5.33	4
A1	0.015	-	0.39	-	4
A2	0.115	0.195	2.93	4.95	-
В	0.014	0.022	0.356	0.558	-
B1	0.045	0.070	1.15	1.77	8, 10
С	0.008	0.014	0.204	0.355	-
D	0.355	0.400	9.01	10.16	5
D1	0.005	-	0.13	-	5
Е	0.300	0.325	7.62	8.25	6
E1	0.240	0.280	6.10	7.11	5
е	0.100	BSC	2.54 BSC		-
e <sub>A</sub>	0.300	BSC	7.62 BSC		6
e <sub>B</sub>	-	0.430	-	10.92	7
L	0.115	0.150	2.93	3.81	4
Ν	8	3	8		9

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### Small Outline Plastic Packages (SOIC)



#### NOTES:

- 1. Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication Number 95.
- 2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
- Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion and gate burrs shall not exceed 0.15mm (0.006 inch) per side.
- Dimension "E" does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.25mm (0.010 inch) per side.
- 5. The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
- 6. "L" is the length of terminal for soldering to a substrate.
- 7. "N" is the number of terminal positions.
- 8. Terminal numbers are shown for reference only.
- 9. The lead width "B", as measured 0.36mm (0.014 inch) or greater above the seating plane, shall not exceed a maximum value of 0.61mm (0.024 inch).
- 10. Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact.

#### M8.15 (JEDEC MS-012-AA ISSUE C) 8 LEAD NARROW BODY SMALL OUTLINE PLASTIC PACKAGE

	INC	IES	MILLIMETERS			
SYMBOL	MIN	MAX	MIN	MAX	NOTES	
А	0.0532	0.0688	1.35	1.75	-	
A1	0.0040	0.0098	0.10	0.25	-	
В	0.013	0.020	0.33	0.51	9	
С	0.0075	0.0098	0.19	0.25	-	
D	0.1890	0.1968	4.80	5.00	3	
E	0.1497	0.1574	3.80	4.00	4	
е	0.050 BSC		1.27 BSC		-	
Н	0.2284	0.2440	5.80	6.20	-	
h	0.0099	0.0196	0.25	0.50	5	
L	0.016	0.050	0.40	1.27	6	
Ν	8		8		7	
α	0°	8°	0°	8°	-	

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